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FAIRCHILD SEMICONDUCTOR®

October 2008

FDS4897AC

Dual N & P-Channel PowerTrench® MOSFET

N-Channel: 40 V, 6.1 A, 26 mΩ P-Channel: -40 V, -5.2 A, 39 mΩ

Features

Q1: N-Channel

- Max $r_{DS(on)}$ = 26 mΩ at V_{GS} = 10 V, I_D = 6.1 A
- Max $r_{DS(on)}$ = 31 mΩ at V_{GS} = 4.5 V, I_D = 5.6 A

Q2: P-Channel

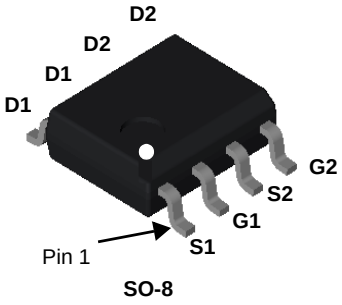
- Max $r_{DS(on)}$ = 39 mΩ at V_{GS} = -10 V, I_D = -5.2 A
- Max $r_{DS(on)}$ = 65 mΩ at V_{GS} = -4.5 V, I_D = -4.1 A
- 100% UIL Tested
- RoHS Compliant

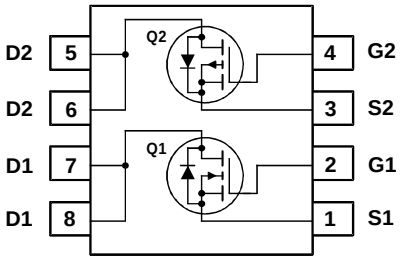
General Description

These dual N- and P-Channel MOSFETs are produced using Fairchild Semiconductor's advanced PowerTrench® process that has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

Applications

- Inverter
- Power Supplies





MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter		Q1	Q2	Units
V_{DS}	Drain to Source Voltage		40	-40	V
V_{GS}	Gate to Source Voltage		±20	±20	V
I_D	Drain Current - Continuous		6.1	-5.2	A
	- Pulsed		24	-24	
P_D	Power Dissipation for Dual Operation		2.0		W
	Power Dissipation for Single Operation	T_A = 25 °C (Note 1a)	1.6		
		T_A = 25 °C (Note 1b)	0.9		
E_{AS}	Single Pulse Avalanche Energy	(Note 3)	37	73	mJ
T_J, T_{STG}	Operating and Storage Junction Temperature Range		-55 to +150		°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case, (Note 1)	40	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction to Ambient, (Note 1a)	78	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDS4897AC	FDS4897AC	SO-8	13 ”	12 mm	2500 units

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Electrical Characteristics T_J = 25 °C unless otherwise noted

Symbol	Parameter	Test Conditions	Type	Min	Typ	Max	Units
Off Characteristics							
BV_{DSS}	Drain to Source Breakdown Voltage	I_D = 250 μA, V_{GS} = 0 V I_D = -250 μA, V_{GS} = 0 V	Q1 Q2	40 -40			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μA, referenced to 25 °C I_D = -250 μA, referenced to 25 °C	Q1 Q2		37 -32		mV/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 32 V, V_{GS} = 0 V V_{DS} = -32 V, V_{GS} = 0 V	Q1 Q2			1 -1	μA
I_{GSS}	Gate to Source Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V	Q1 Q2			±100 ±100	nA nA
On Characteristics							
$V_{GS(th)}$	Gate to Source Threshold Voltage	V_{GS} = V_{DS}, I_D = 250 μA V_{GS} = V_{DS}, I_D = -250 μA	Q1 Q2	1.5 -1.5	2.0 -2.0	3.0 -3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 μA, referenced to 25 °C I_D = -250 μA, referenced to 25 °C	Q1 Q2		-6 6		mV/°C
$r_{DS(on)}$	Static Drain to Source On Resistance	V_{GS} = 10 V, I_D = 6.1 A V_{GS} = 4.5 V, I_D = 5.6 A V_{GS} = 10 V, I_D = 6.1 A, T_J = 125 °C	Q1		20 24 30	26 31 39	mΩ
		V_{GS} = -10 V, I_D = -5.2 A V_{GS} = -4.5 V, I_D = -4.1 A V_{GS} = -10 V, I_D = -5.2 A, T_J = 125 °C	Q2		28 45 41	39 65 57	
g_{FS}	Forward Transconductance	V_{DD} = 5 V, I_D = 6.1 A V_{DD} = -5 V, I_D = -5.2 A	Q1 Q2		24 14		S
Dynamic Characteristics							
C_{iss}	Input Capacitance	Q1 V_{DS} = 20 V, V_{GS} = 0 V, f = 1 MHZ	Q1 Q2		795 765	1055 1015	pF
C_{oss}	Output Capacitance	Q2 V_{DS} = -20 V, V_{GS} = 0 V, f = 1 MHZ	Q1 Q2		95 135	130 180	pF
C_{rss}	Reverse Transfer Capacitance		Q1 Q2		65 80	100 120	pF
R_g	Gate Resistance		Q1 Q2		1.7 3.6		Ω
Switching Characteristics							
$t_{d(on)}$	Turn-On Delay Time	Q1 V_{DD} = 20 V, I_D = 6.1 A, V_{GS} = 10 V, R_{GEN} = 6 Ω	Q1 Q2		6 8	12 15	ns
t_r	Rise Time		Q1 Q2		2 3	10 10	ns
$t_{d(off)}$	Turn-Off Delay Time	Q2 V_{DD} = -20 V, I_D = -5.2 A, V_{GS} = -10 V, R_{GEN} = 6 Ω	Q1 Q2		17 17	30 30	ns
t_f	Fall Time		Q1 Q2		2 3	10 10	ns
$Q_{g(TOT)}$	Total Gate Charge	Q1 V_{GS} = 10 V, V_{DD} = 20 V, I_D = 6.1 A	Q1 Q2		15 15	21 20	nC
Q_{gs}	Gate to Source Charge		Q1 Q2		2.5 2.6		nC
Q_{gd}	Gate to Drain “Miller” Charge	Q2 V_{GS} = -10 V, V_{DD} = -20 V, I_D = -5.2 A	Q1 Q2		2.9 3.2		nC

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Electrical Characteristics T_J = 25 °C unless otherwise noted

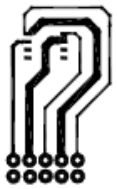
Symbol	Parameter	Test Conditions	Type	Min	Typ	Max	Units
Drain-Source Diode Characteristics							
V_{SD}	Source to Drain Diode Forward Voltage	V_{GS} = 0 V, I_S = 1.3 A (Note 2) V_{GS} = 0 V, I_S = -1.3 A (Note 2)	Q1 Q2		0.75 -0.76	1.2 -1.2	V
t_{rr}	Reverse Recovery Time	Q1 I_F = 6.1 A, di/dt = 100 A/s	Q1 Q2		17 20	31 36	ns
Q_{rr}	Reverse Recovery Charge	Q2 I_F = -5.2 A, di/dt = 100 A/s	Q1 Q2		7 10	15 20	nC

Notes:

1: $R_{\theta JA}$ is determined with the device mounted on a 1in^2 pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a) 78 °C/W when mounted on a 1 in^2 pad of 2 oz copper



b) 135 °C/W when mounted on a minimun pad

2: Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0%.

3: Starting T_J = 25 °C, N-ch: L = 3 mH, I_{AS} = 5 A, V_{DD} = 40 V, V_{GS} = 10 V; P-ch: L = 3 mH, I_{AS} = -7 A, V_{DD} = -40 V, V_{GS} = -10 V.

Typical Characteristics (Q1 N-Channel) T_J = 25 °C unless otherwise noted

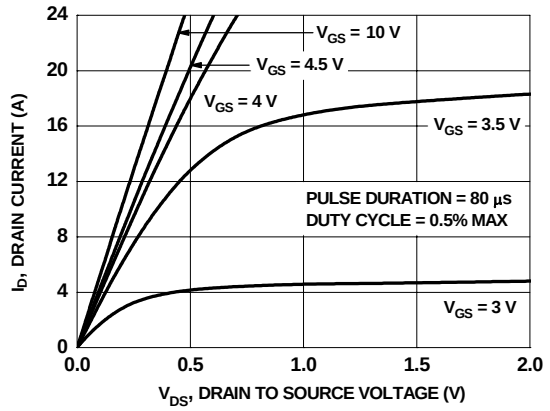


Figure 1. On Region Characteristics

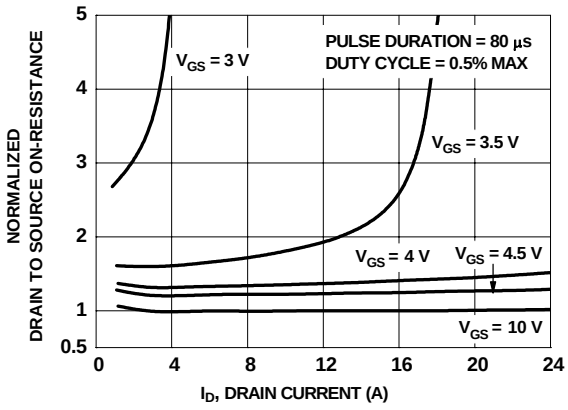


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

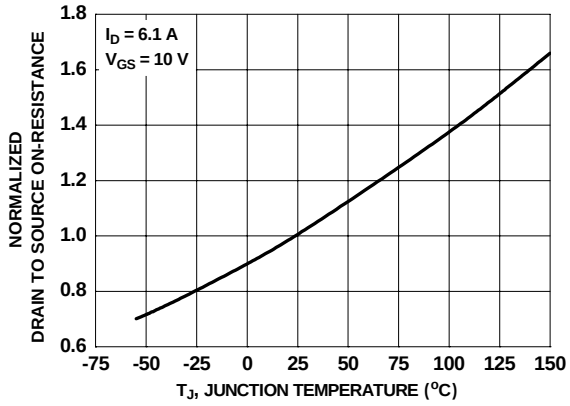


Figure 3. Normalized On Resistance vs Junction Temperature

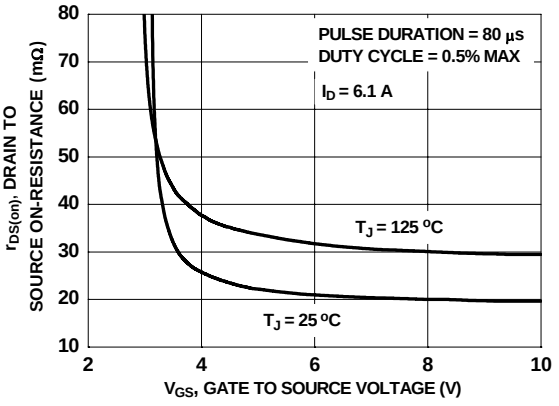


Figure 4. On-Resistance vs Gate to Source Voltage

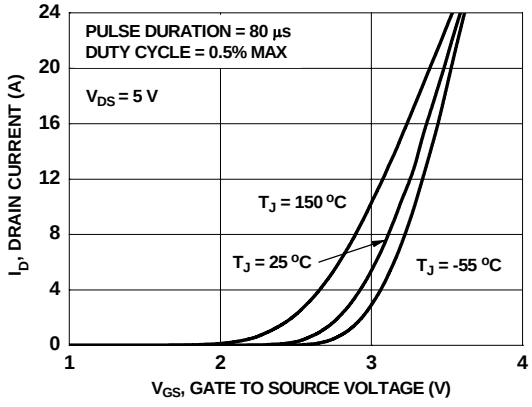


Figure 5. Transfer Characteristics

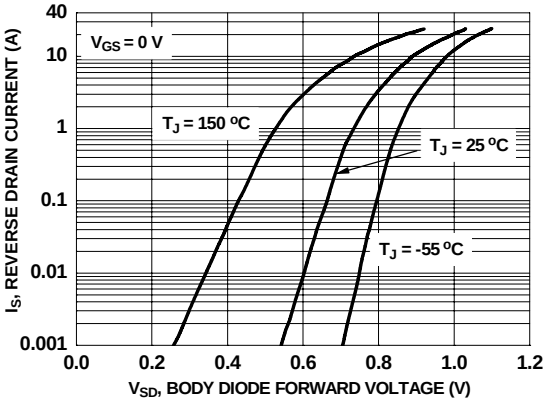


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics (Q1 N-Channel) T_J = 25 °C unless otherwise noted

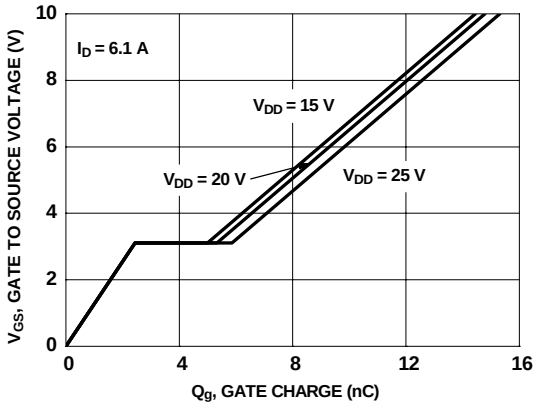


Figure 7. Gate Charge Characteristics

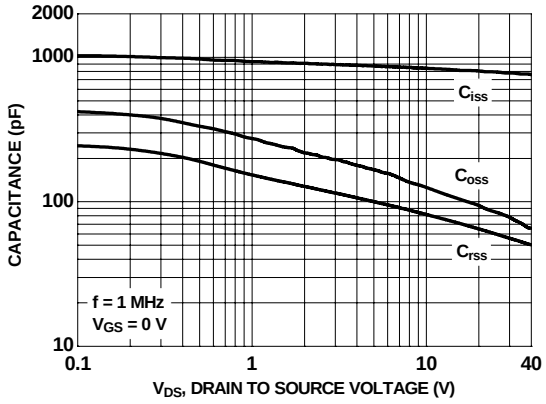


Figure 8. Capacitance vs Drain to Source Voltage

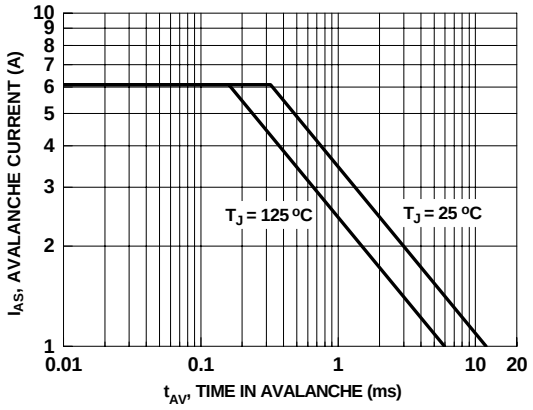


Figure 9. Unclamped Inductive Switching Capability

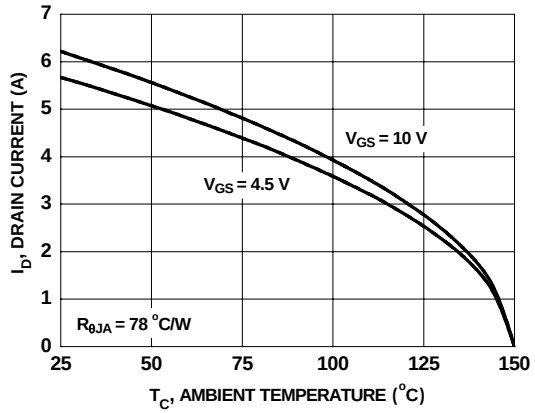


Figure 10. Maximum Continuous Drain Current vs Ambient Temperature

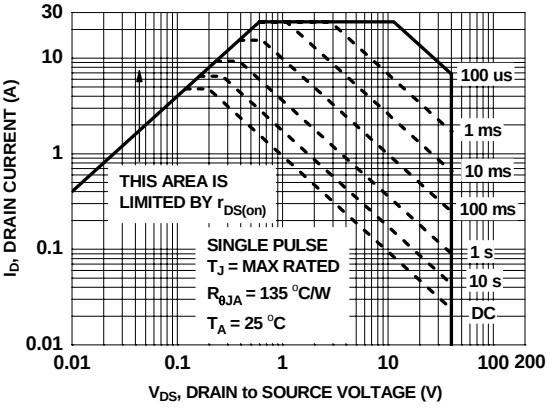


Figure 11. Forward Bias Safe Operating Area

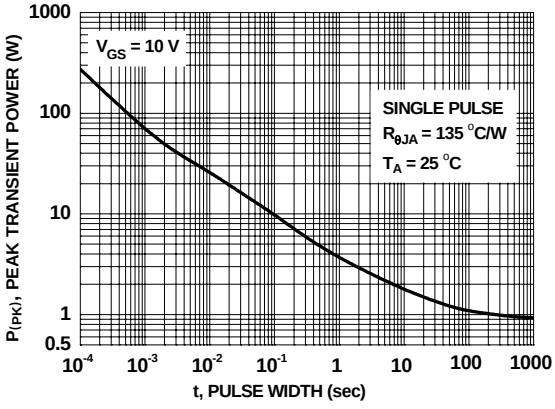


Figure 12. Single Pulse Maximum Power Dissipation

Typical Characteristics (Q1 N-Channel) T_J = 25 °C unless otherwise noted

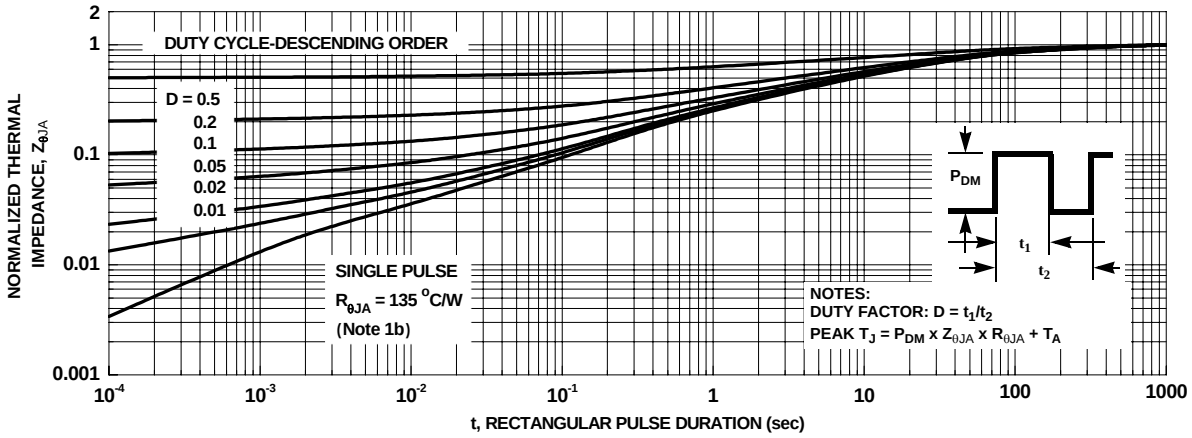


Figure 13. Junction-to-Ambient Transient Thermal Response Curve

Typical Characteristics (Q2 P-Channel) T_J = 25 °C unless otherwise noted

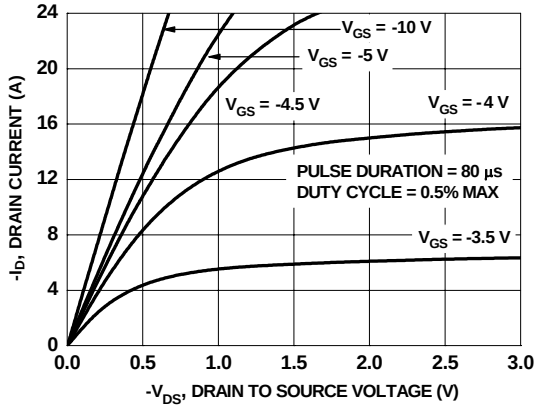


Figure 15. On- Region Characteristics

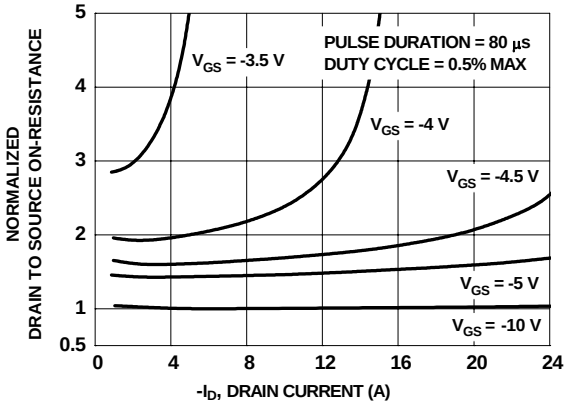


Figure 16. Normalized on-Resistance vs Drain Current and Gate Voltage

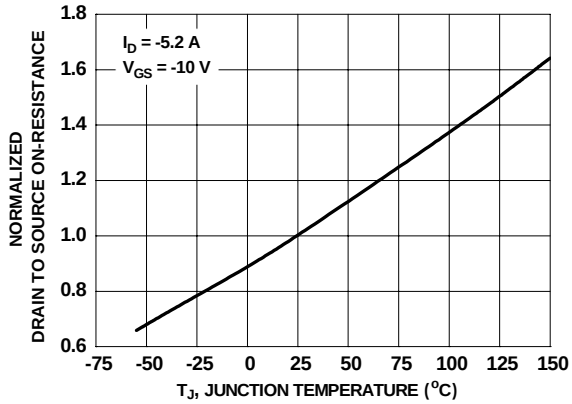


Figure 17. Normalized On-Resistance vs Junction Temperature

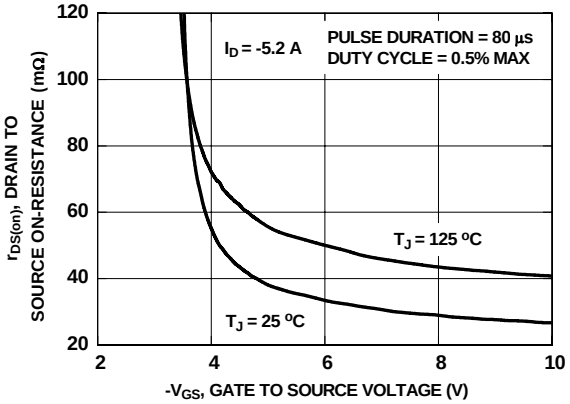


Figure 18. On-Resistance vs Gate to Source Voltage

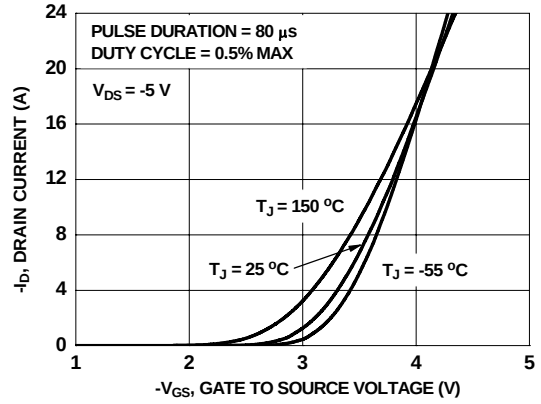


Figure 19. Transfer Characteristics

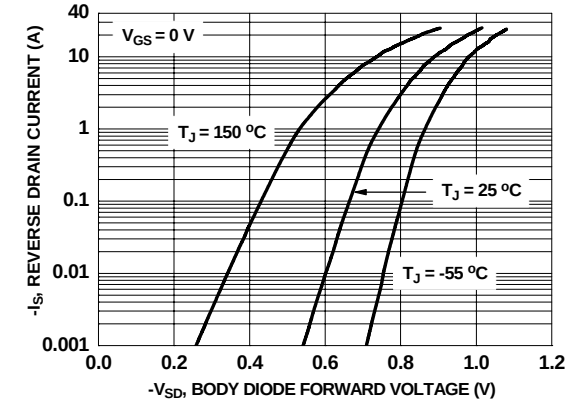


Figure 20. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics (Q2 P-Channel) T_J = 25 °C unless otherwise noted

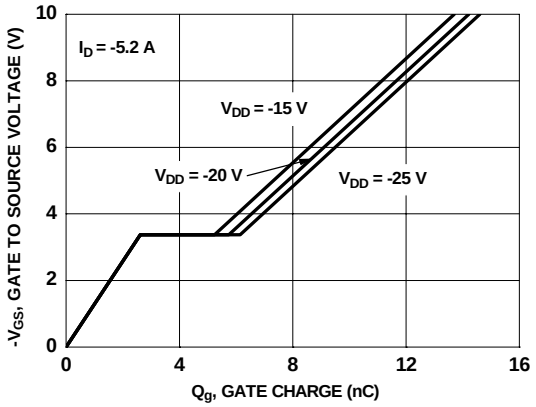


Figure 21. Gate Charge Characteristics

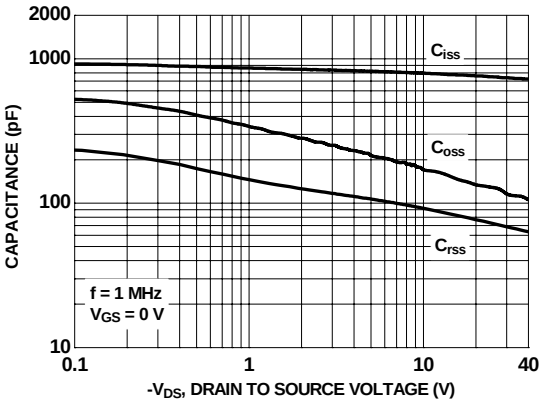


Figure 22. Capacitance vs Drain to Source Voltage

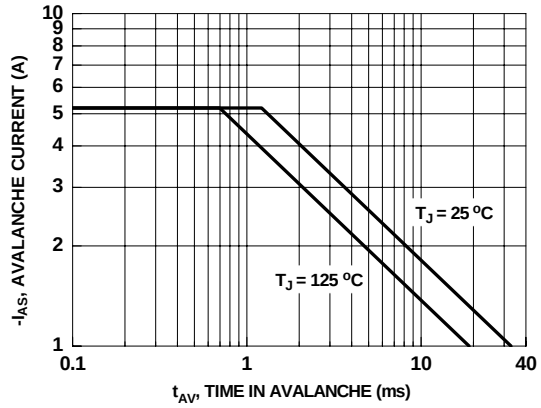


Figure 23. Unclamped Inductive Switching Capability

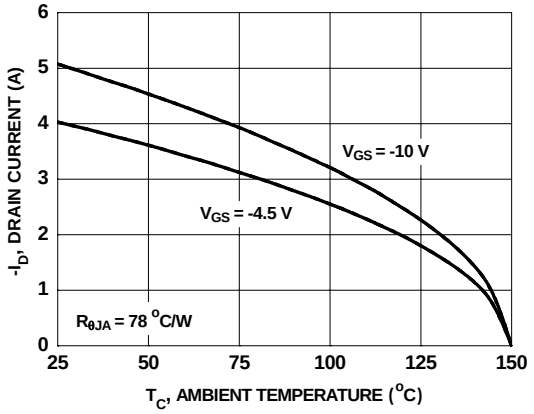


Figure 24. Maximum Continuous Drain Current vs Ambient Temperature

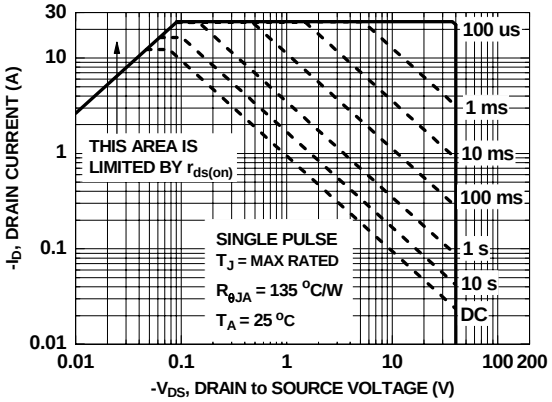


Figure 25. Forward Bias Safe Operating Area

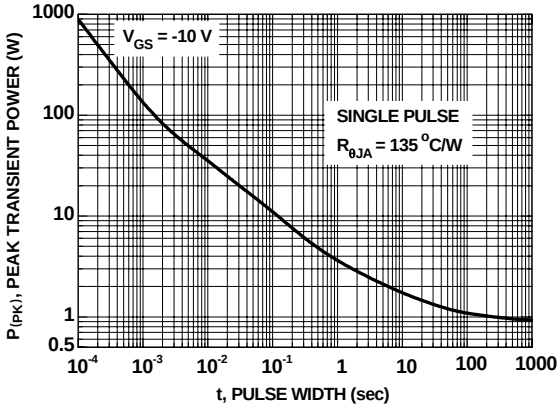


Figure 26. Single Pulse Maximum Power Dissipation

Typical Characteristics (Q2 P-Channel) T_J = 25 °C unless otherwise noted

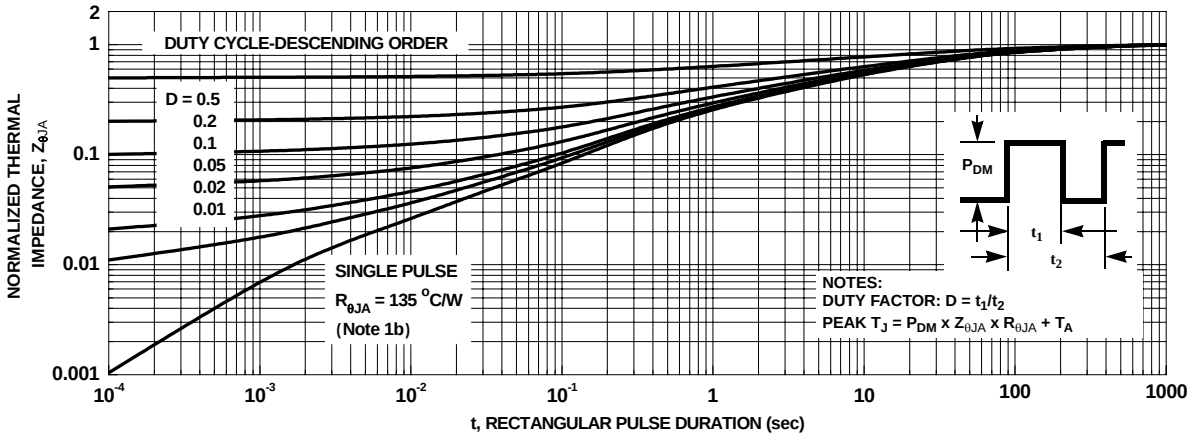


Figure 27. Junction-to-Ambient Transient Thermal Response Curve

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2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Definition of Terms

Datasheet Identification	Product Status	Definition
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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
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